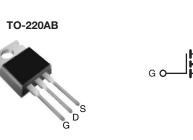


Vishay Siliconix

Power MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	400				
R _{DS(on)} (Ω)	$V_{GS} = 10 V$	0.55			
Q _g (Max.) (nC)	63				
Q _{gs} (nC)	9.0				
Q _{gd} (nC)	32				
Configuration	Single				



S N-Channel MOSFET

FEATURES

- Dynamic dV/dt Rating
- Repetitive Avalanche Rated
- · Fast Switching
- Ease of Paralleling
- Simple Drive Requirements
- Compliant to RoHS Directive 2002/95/EC

DESCRIPTION

Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220AB package is universally preferred for all commercial-industrial applications at power dissipation levels to approximately 50 W. The low thermal resistance and low package cost of the TO-220AB contribute to its wide acceptance throughout the industry.

ORDERING INFORMATION	
Package	TO-220AB
Lead (Pb)-free	IRF740PbF
	SiHF740-E3
SnPb	IRF740
	SiHF740

ABSOLUTE MAXIMUM RATINGS (T_C	= 25 °C, unl	ess otherwis	se noted)			
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage		V _{DS}	400	V		
Gate-Source Voltage			V _{GS}			± 20
Continuous Drain Current	V at 10 V	T _C = 25 °C	- I _D	10		
	V _{GS} at 10 V	$T_C = 100 \ ^\circ C$		6.3	А	
Pulsed Drain Current ^a			I _{DM}	40		
Linear Derating Factor				1.0	W/°C	
Single Pulse Avalanche Energy ^b			E _{AS}	520	mJ	
Repetitive Avalanche Current ^a			I _{AR}	10	А	
Repetitive Avalanche Energy ^a			E _{AR}	13	mJ	
Maximum Power Dissipation	T _C =	25 °C	P _D 125		W	
Peak Diode Recovery dV/dt ^c			dV/dt	4.0	V/ns	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to + 150	°C		
Soldering Recommendations (Peak Temperature)	for 10 s		-	300 ^d		
Mounting Torque	6.00 or 1	6.00 er M0 eereu		10	lbf ∙ in	
	6-32 or M3 screw		Ē	1.1	N · m	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. $V_{DD} = 50$ V, starting $T_J = 25$ °C, L = 9.1 mH, $R_q = 25 \Omega$, $I_{AS} = 10$ A (see fig. 12).

c. $I_{SD} \leq 10$ A, dl/dt ≤ 120 A/µs, $V_{DD} \leq V_{DS}$, $T_J \leq 150$ °C.

d. 1.6 mm from case.

* Pb containing terminations are not RoHS compliant, exemptions may apply

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THERMAL RESISTANCE RATI	NGS									
PARAMETER	SYMBOL	TYP.		MAX.		UNIT				
Maximum Junction-to-Ambient	R _{thJA}	-		62						
Case-to-Sink, Flat, Greased Surface	R _{thCS}	0.50	50 -			°C/W				
Maximum Junction-to-Case (Drain)	R _{thJC}	-		1.0			1			
SPECIFICATIONS (T _J = 25 $^{\circ}$ C, u	nless otherw	ise noted)								
PARAMETER	SYMBOL	TEST	CONDITIC	ONS	MIN.	TYP.	MAX.	UNIT		
Static										
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0$	0 V, I _D = 25	50 µA	400	-	-	V		
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	to 25 °C, I	_D = 1 mA	1	0.49	-	V/°C		
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V$	/ _{GS} , I _D = 2	50 µA	2.0	-	4.0	V		
Gate-Source Leakage	I _{GSS}	$V_{GS} = \pm 20 \text{ V}$			-	-	± 100	nA		
Zero Gate Voltage Drain Current	laaa	$V_{DS} = 400 \text{ V}, V_{GS} = 0 \text{ V}$		-	-	25				
Zero Gale Voltage Drain Gurrent	I _{DSS}	V _{DS} = 320 V, ¹	V_{DS} = 320 V, V_{GS} = 0 V, T_{J} = 125 $^{\circ}\text{C}$		-	-	250	μA		
Drain-Source On-State Resistance	R _{DS(on)}	$V_{GS} = 10 V$	I _D	= 6.0 A ^b	-	-	0.55	Ω		
Forward Transconductance	9 _{fs}	$V_{DS} = 50 \text{ V}, \text{ I}_{D} = 6.0 \text{ A}^{b}$		5.8	-	-	S			
Dynamic		_				_	_			
Input Capacitance	C _{iss}	١	$I_{\rm GS} = 0 \rm V,$		-	1400	-			
Output Capacitance	C _{oss}	V _{DS} = 25 V,			-	330	-	pF		
Reverse Transfer Capacitance	C _{rss}	f = 1.0 MHz, see fig. 5			-	120	-			
Total Gate Charge	Qg				-	-	63			
Gate-Source Charge	Q _{gs}	$V_{GS} = 10 \text{ V}$ $I_D = 10 \text{ A}, V_{DS} = 320 \text{ V},$		-	-	9.0	nC			
Gate-Drain Charge	Q _{gd}		see fig. 6 and 13 ^b		-	-	32	1		
Turn-On Delay Time	t _{d(on)}		1		-	14	-			
Rise Time	t _r	V_{DD} = 200 V, I _D = 10 A R _g = 9.1 Ω , R _D = 20 Ω , see fig. 10 ^b		-	27	-	ns			
Turn-Off Delay Time	t _{d(off)}			-	50	-				
Fall Time	t _f			-	24	-				
Internal Drain Inductance	L _D	Between lead, 6 mm (0.25") from package and center of die contact		-	4.5	-	nH			
Internal Source Inductance	L _S			-	7.5	-				
Drain-Source Body Diode Characteristic	s	·								
Continuous Source-Drain Diode Current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	10	A			
Pulsed Diode Forward Current ^a	I _{SM}			-	-	40				
Body Diode Voltage	V _{SD}	T _J = 25 °C, I _S = 10 A, V _{GS} = 0 V ^b		-	-	2.0	V			
Body Diode Reverse Recovery Time	t _{rr}	$T_J = 25 \text{ °C}, I_F = 10 \text{ A}, dI/dt = 100 \text{ A}/\mu\text{s}^{b}$		-	370	790	ns			
Body Diode Reverse Recovery Charge	Q _{rr}			-	3.8	8.2	μC			
Forward Turn-On Time	t _{on}	Intrinsic turn-on time is negligible (turn-			-on is do	minated h	v Ls and	L _D)		

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. Pulse width \leq 300 µs; duty cycle \leq 2 %.

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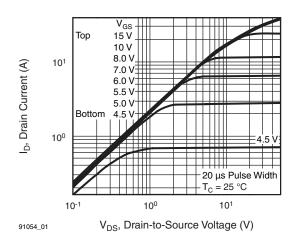


Fig. 1 - Typical Output Characteristics, T_C = 25 °C

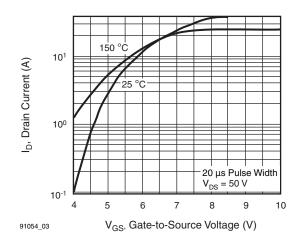


Fig. 3 - Typical Transfer Characteristics

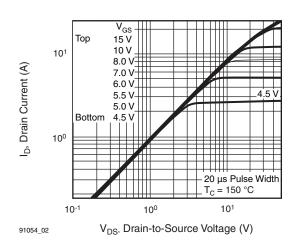


Fig. 2 - Typical Output Characteristics, $T_C = 150 \ ^{\circ}C$

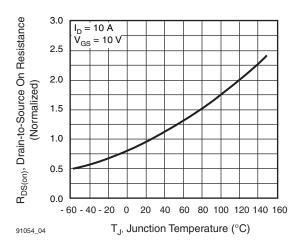


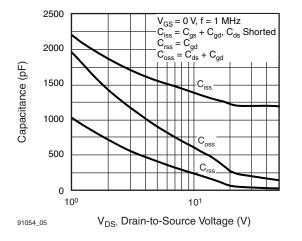
Fig. 4 - Normalized On-Resistance vs. Temperature

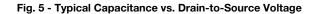
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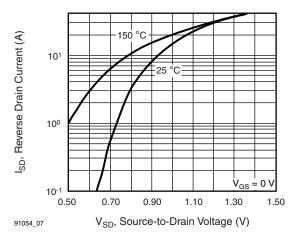
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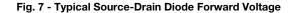
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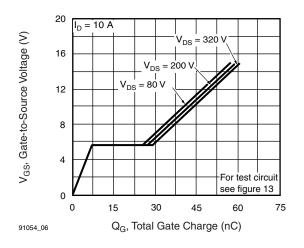


Fig. 6 - Typical Gate Charge vs. Drain-to-Source Voltage

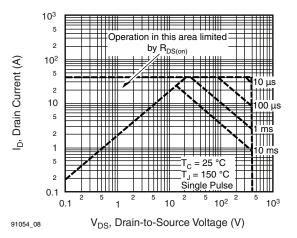


Fig. 8 - Maximum Safe Operating Area

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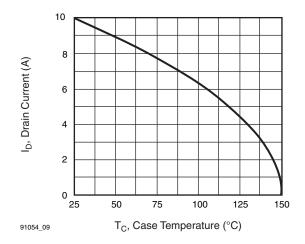


Fig. 9 - Maximum Drain Current vs. Case Temperature

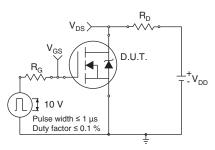


Fig. 10a - Switching Time Test Circuit

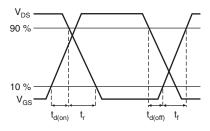


Fig. 10b - Switching Time Waveforms

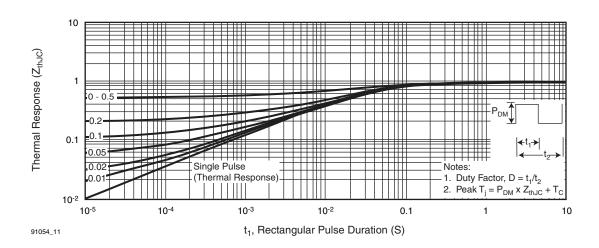


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

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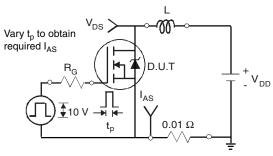


Fig. 12a - Unclamped Inductive Test Circuit

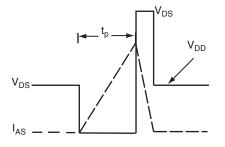
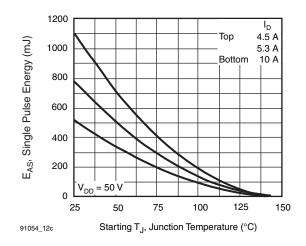
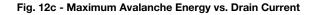
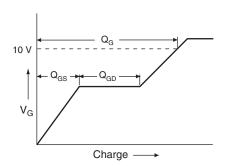


Fig. 12b - Unclamped Inductive Waveforms









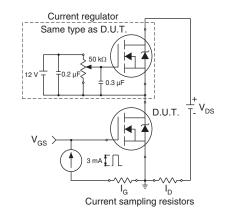
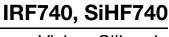


Fig. 13b - Gate Charge Test Circuit

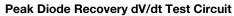
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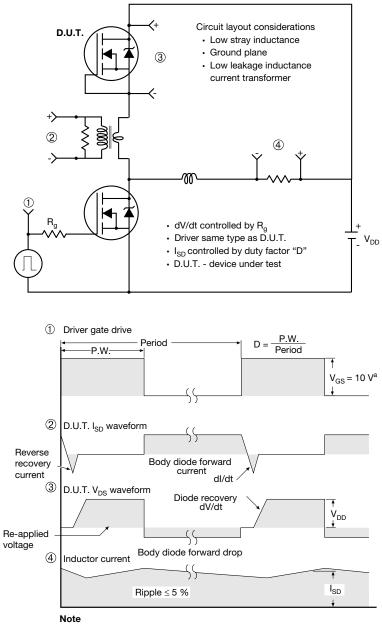
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a. $V_{GS} = 5 V$ for logic level devices

Fig. 14 - For N-Channel

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